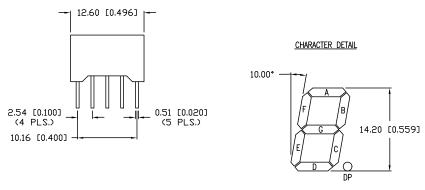
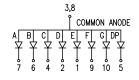


PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH	5	85 (YELLO)	N)	nm	
FORWARD VOLTAGE		2.1	2.5	V_{f}	
REVERSE VOLTAGE	5.0			V_r	Ir=100µA
axial intensity		3900		μcd	$I_f = 10mA$
EMITTED COLOR:	YELLOW				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY W	HITE DIFFU	SED		



LIMITS OF SAFE OPERATION AT 25°	C PER CHIP	
PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	- 1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	•C
SOLDERING TEMP.	+ 260	•c
2.0mm FROM BODY		3 SEC. MAX
* t<10uS		



UNCONTROLLED DOCUMENT *UNLESS OTHERWISE SPECIFIED TOLERANCE IS ±0.25mm (±0.010")

PART NUMBER REV. LDS-A5643RI THE INFORMATION CONTINENTIAL INFORMATION
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0.56" SEVEN SEGMENT, SINGLE DIGIT DISPLAY, OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE
THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE
FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS. 585nm YELLOW CHIPS, GRAY FACE WITH WHITE SEGMENTS, COMMON ANODE, RIGHT DECIMAL POINT.

PAGE: 1 OF 1 SCALE: N/A